

AMPMODU | Modu Connector System

TE Internal #: 5-534998-8 PCB Mount Receptacle, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **16**

Number of Rows: 2

Features

Product Type Features

Applied Pressure

PCB Connector Assembly Type

Connector System

Standard

PCB Mount Receptacle

Board-to-Board

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	16
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	333 VAC
Body Features	
Connector Profile	Low
Primary Product Color	Black

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Contact Features

Contact Mating Area Length3.77 mm[.148 in]Mating Square Post Dimension.64 mm[.025 in]PCB Contact Termination Area Plating Material Thickness3.81 – 7.61 µmContact Shape & FormRoundPCB Contact Termination Area Plating MaterialTinContact Base MaterialPhosphor BronzeContact Mating Area Plating MaterialGold
PCB Contact Termination Area Plating Material Thickness $3.81 - 7.61 \mu m$ Contact Shape & FormRoundPCB Contact Termination Area Plating MaterialTinContact Base MaterialPhosphor Bronze
Contact Shape & FormRoundPCB Contact Termination Area Plating MaterialTinContact Base MaterialPhosphor Bronze
PCB Contact Termination Area Plating Material Tin Contact Base Material Phosphor Bronze
Contact Base Material Phosphor Bronze
Contact Mating Area Plating Material Gold
Contact Mating Area Plating Material Thickness .762 µm[30 µin]
Contact Type Socket
Contact Current Rating (Max) 2 A
Termination Features
Rectangular Termination Post & Tail Thickness .2 mm[.008 in]
Rectangular Termination Post & Tail Width .7 mm[.028 in]
Termination Post & Tail Length 3.18 mm[.125 in]

Through Hole - Solder

Termination Method to Printed Circuit Board

Mechanical Attachment

Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Mating Entry Location	Тор	
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Connector Height	5.03 mm[.198 in]	
Row-to-Row Spacing	2.54 mm[.1 in]	
Stack Height	9.02 mm[.355 in]	
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]	
Usage Conditions		

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Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]	
Operation/Application		
Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	28	
Packaging Type	Box, Tube	
Product Compliance		
For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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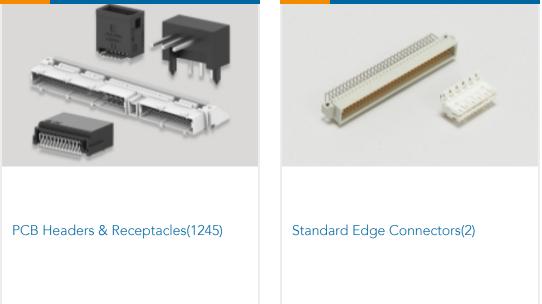


Compatible Parts



Also in the Series | Modu Connector System

Automotive Housings(2)	Board-to-Board Jumpers & Shunts(5)	PCB Connector Covers(4)	PCB Connector Keying(4)





Customers Also Bought



PCB Mount Receptacle, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System







Documents

Product Drawings 16 MODIV VRT DR CE 100/125

English

CAD Files Customer View Model ENG_CVM_CVM_5-534998-8_R.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-534998-8_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-534998-8_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

Product Specifications
Application Specification

English